



Description

JMT N-channel Enhancement Mode Power MOSFET

Features

- 30V,130A
- $R_{DS(ON)} < 1.8\text{m}\Omega$ @ $V_{GS} = 10\text{V}$
- $R_{DS(ON)} < 3.0\text{m}\Omega$ @ $V_{GS} = 4.5\text{V}$
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free

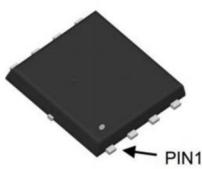
Application

- Load Switch
- PWM Application
- Power Management

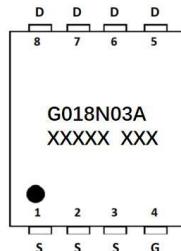


100% UIS TESTED!
100% ΔV_{ds} TESTED!

Top View

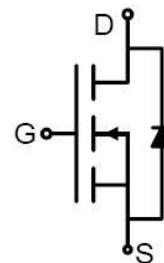


Bottom View



PDFN5x6-8L

Marking and pin Assignment



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Outline | Package | Reel Size | Reel (pcs) | Per Carton (pcs) |
|----------------|-------------|---------|------------|-----------|------------|------------------|
| G018N03A | JMTG018N03A | TAPING | PDFN5x6-8L | 13" | 2500 | 25000 |

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | | Max. | Units |
|-----------------|---|---------------------------|-------------|---------------------------|
| V_{DSS} | Drain-Source Voltage | | 30 | V |
| V_{GSS} | Gate-Source Voltage | | ± 20 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ\text{C}$ | 130 | A |
| | | $T_c = 100^\circ\text{C}$ | 85 | A |
| I_{DM} | Pulsed Drain Current ^{note1} | | 520 | A |
| E_{AS} | Single Pulsed Avalanche Energy ^{note2} | | 225 | mJ |
| P_D | Power Dissipation | $T_c = 25^\circ\text{C}$ | 51 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 2.5 | $^\circ\text{C}/\text{W}$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | | -55 to +150 | $^\circ\text{C}$ |

**Electrical Characteristics** ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|--|------|------|-----------|------------------|
| Off Characteristics | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ | 30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=30\text{V}$, $V_{GS}=0\text{V}$, | - | - | 1.0 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$ | 1.0 | 1.6 | 2.5 | V |
| $R_{DS(\text{on})}$ note3 | Static Drain-Source on-Resistance | $V_{GS}=10\text{V}$, $I_D=30\text{A}$ | - | 1.4 | 1.8 | $\text{m}\Omega$ |
| | | $V_{GS}=4.5\text{V}$, $I_D=20\text{A}$ | - | 2.3 | 3.0 | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=15\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 6682 | - | pF |
| C_{oss} | Output Capacitance | | - | 971 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 627 | - | pF |
| Q_g | Total Gate Charge | $V_{DD}=15\text{V}$, $I_D=30\text{A}$, $V_{GS}=10\text{V}$ | - | 93 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 14 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 21 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD}=15\text{V}$, $I_D=30\text{A}$, $R_{\text{GEN}}=3\Omega$, $V_{GS}=10\text{V}$ | - | 16 | - | ns |
| t_r | Turn-on Rise Time | | - | 9 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 65 | - | ns |
| t_f | Turn-off Fall Time | | - | 18 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_s | Maximum Continuous Drain to Source Diode Forward Current | - | - | 130 | A | |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 520 | A | |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_s=30\text{A}$ | - | - | 1.2 | V |
| trr | Body Diode Reverse Recovery Time | $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | - | 29 | - | ns |
| Qrr | Body Diode Reverse Recovery Charge | | - | 19 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: Starting $T_J=25^\circ\text{C}$, $V_{DD}=27\text{V}$, $V_G=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$, $I_{AS}=30\text{A}$ 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Performance Characteristics

Figure 1: Output Characteristics

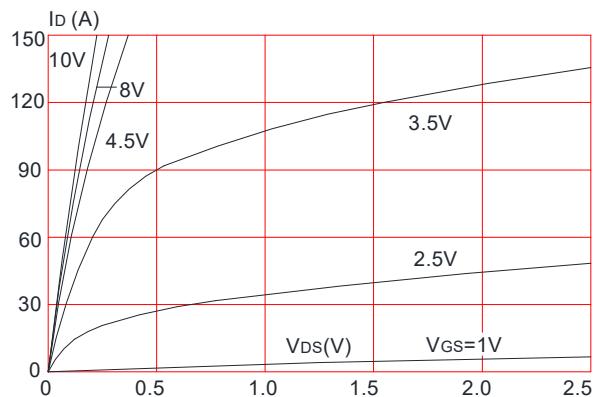


Figure 3: On-resistance vs. Drain Current

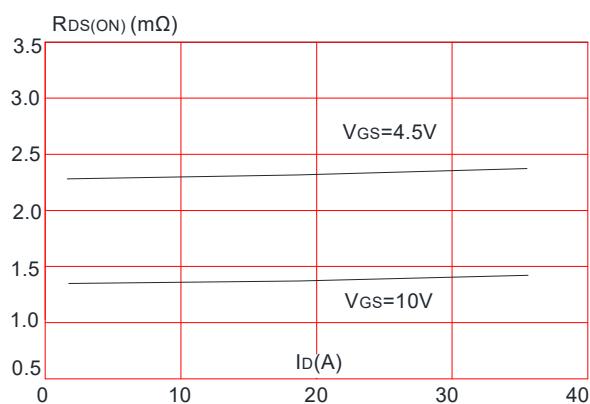


Figure 5: Gate Charge Characteristics

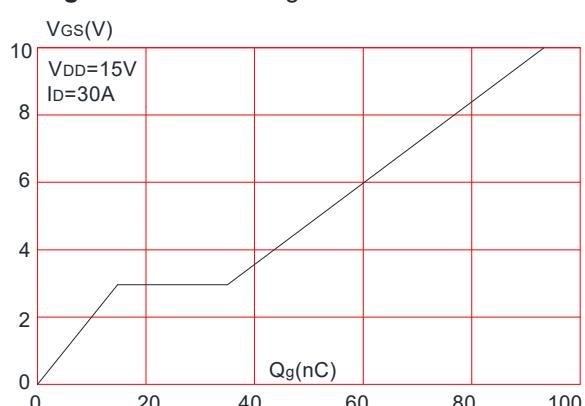


Figure 2: Typical Transfer Characteristics

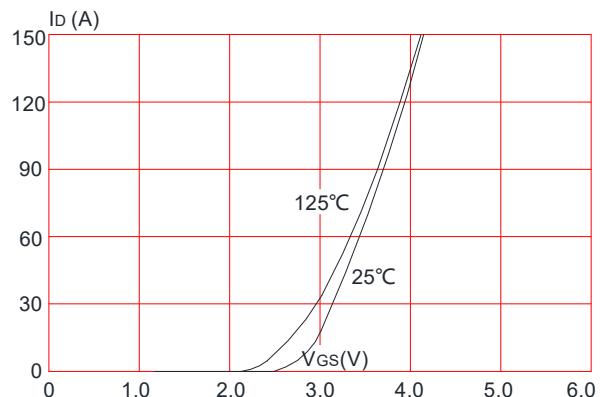


Figure 4: Body Diode Characteristics

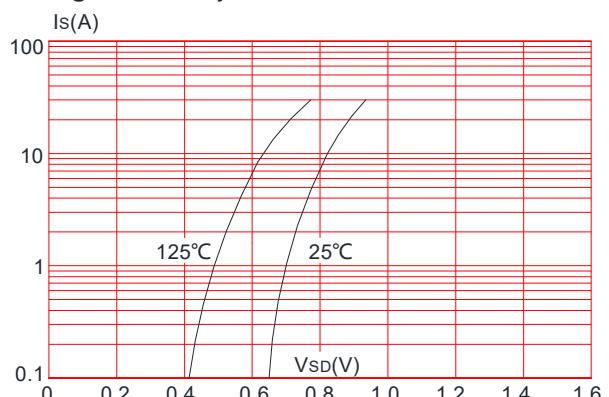


Figure 6: Capacitance Characteristics

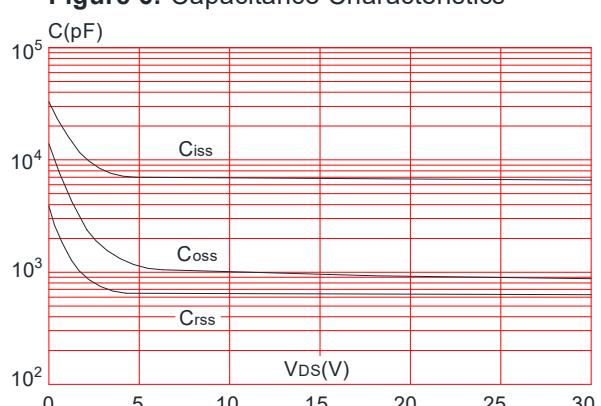


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

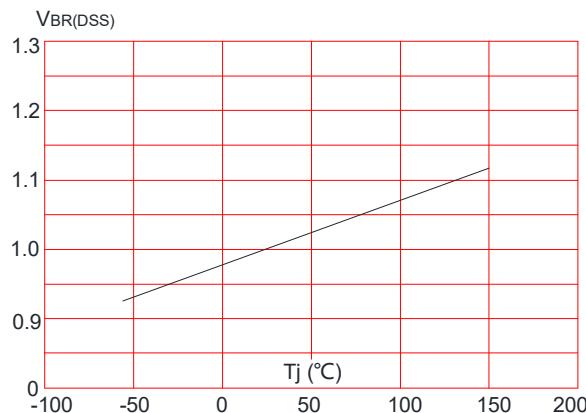


Figure 8: Normalized on Resistance vs. Junction Temperature

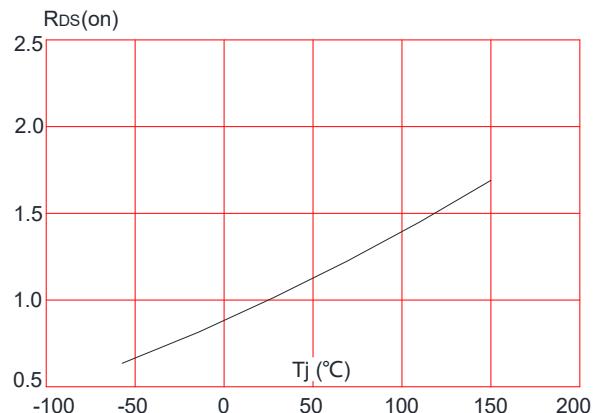


Figure 9: Maximum Safe Operating Area

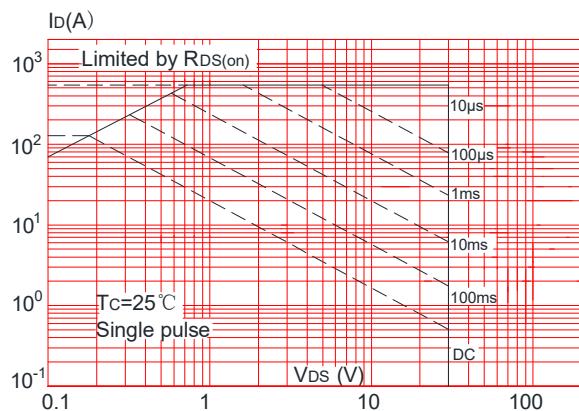


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

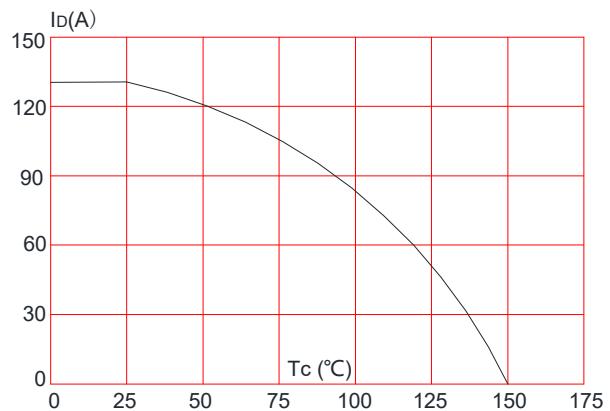
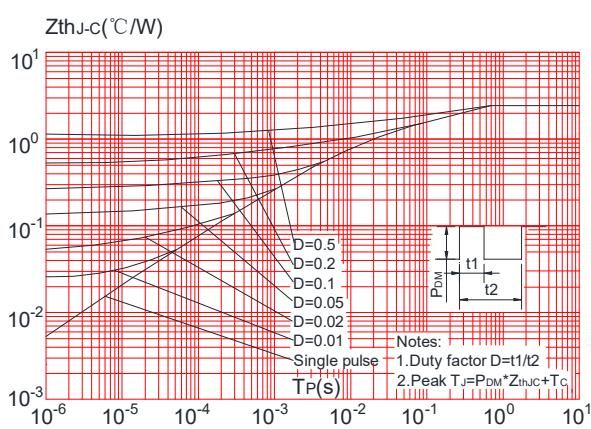


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case



Test Circuit

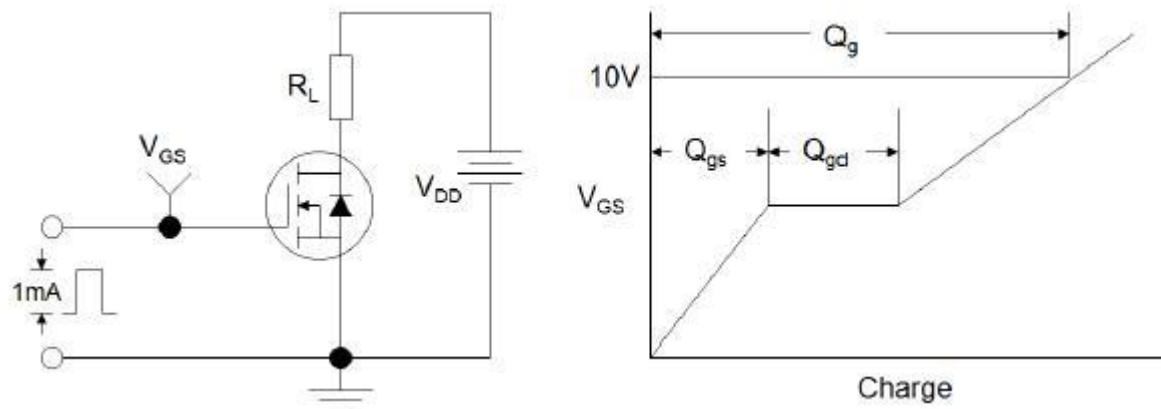


Figure1:Gate Charge Test Circuit & Waveform

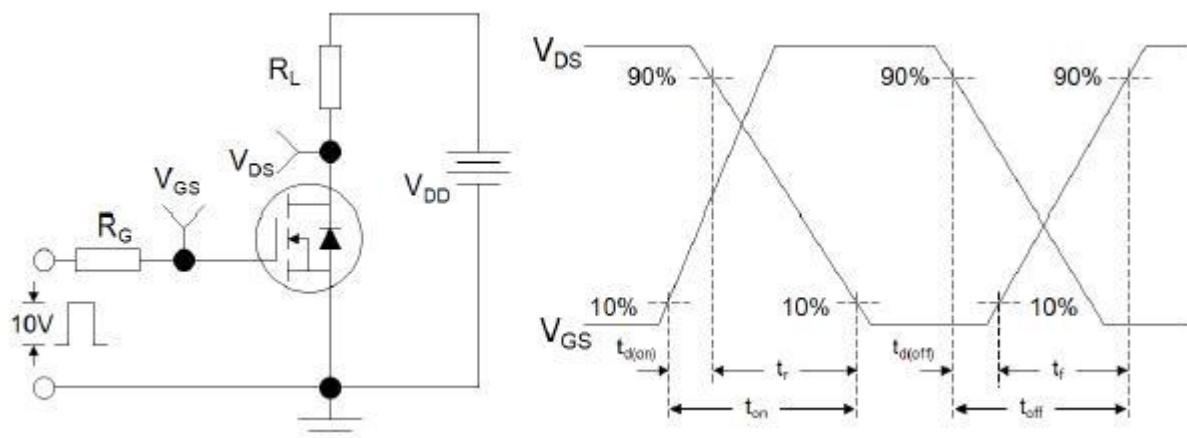


Figure 2: Resistive Switching Test Circuit & Waveforms

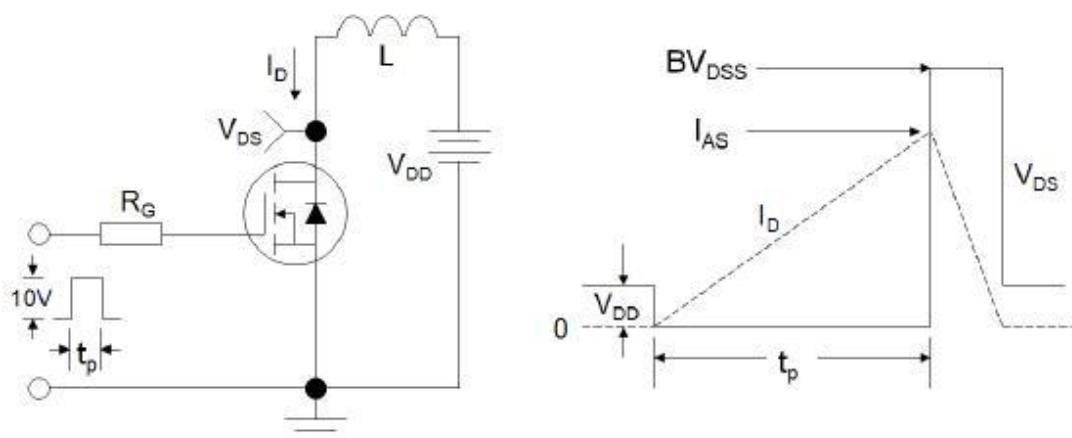
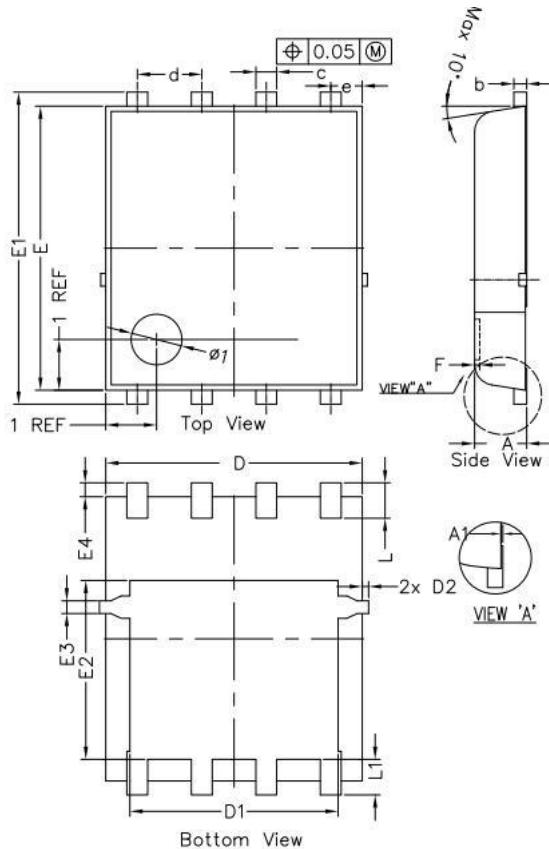


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms



Package Mechanical Data-PDFN5x6-8L



| SYMBOLS | DIMENSION IN MM | | | DIMENSION IN INCHES | | |
|---------|-----------------|-------|-------|---------------------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| * A | 0.900 | 1.000 | 1.100 | 0.035 | 0.039 | 0.043 |
| A1 | 0.000 | --- | 0.050 | 0.000 | ---- | 0.002 |
| b | 0.246 | 0.254 | 0.312 | 0.010 | 0.010 | 0.012 |
| * c | 0.310 | 0.410 | 0.510 | 0.012 | 0.016 | 0.020 |
| d | 1.27 BSC | | | 0.050 BSC | | |
| * D | 4.950 | 5.050 | 5.150 | 0.195 | 0.199 | 0.203 |
| D1 | 4.000 | 4.100 | 4.200 | 0.157 | 0.161 | 0.165 |
| * D2 | --- | --- | 0.125 | --- | --- | 0.005 |
| e | 0.62 BSC | | | 0.024 BSC | | |
| * E | 5.500 | 5.600 | 5.700 | 0.217 | 0.220 | 0.224 |
| * E1 | 6.050 | 6.150 | 6.250 | 0.238 | 0.242 | 0.246 |
| E2 | 3.425 | 3.525 | 3.625 | 0.135 | 0.139 | 0.143 |
| E3 | 0.150 | 0.250 | 0.350 | 0.006 | 0.010 | 0.014 |
| * E4 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| F | - | - | 0.100 | - | - | 0.004 |
| * L | 0.500 | 0.600 | 0.700 | 0.02 | 0.02 | 0.03 |
| L1 | 0.600 | 0.700 | 0.800 | 0.02 | 0.03 | 0.03 |

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